



an Open Access Journal by MDPI

# Advances in Nanostructured Thermoelectric Materials and Devices

Guest Editors:

### Dr. Weidi Liu

Australian Institute for Bioengineering and Nanotechnology, the University of Queensland, Brisbane, QLD 4072, Australia

#### Dr. He Zhu

School of Materials Science and Engineering, Nanjing University of Science and Technology, Nanjing 210094, China

#### Dr. Jianhui Qi

School of Energy and Power Engineering, Shandong University, Jinan 250061, China

Deadline for manuscript submissions: closed (10 May 2023)

### Message from the Guest Editors

Dear Colleagues,

Thermoelectric technology can realize direct and reversible energy conversion between heat and electricity. Correspondingly, thermoelectric technology possesses various application advantages, such as being emissionfree, eco-friendly, vibration-free, noise-free, scalable, maintenance-free, etc. With these advantages and the recent rapid development of thermoelectric materials, thermoelectric technology has demonstrated extensive application potential, including but not limited to localized temperature control, personal thermal management, portable freezing, building air-conditioning, waste heat recovery, space-mission power generation, etc. Regardless of the fast development of thermoelectric technology, various challenges remain unsolved and need to be further addressed. ranging from material engineering, understanding the material-structure relationship, device design and application integration, which have attracted ever-increasing research interest. In this Special Issue, we welcome contributions to our understanding of thermoelectric materials, devices, and their applications.



mdpi.com/si/118917







an Open Access Journal by MDPI

## **Editor-in-Chief**

### Message from the Editor-in-Chief

You are invited to contribute research articles or comprehensive reviews for consideration and publication in *Micromachines* (ISSN 2072-666X). *Micromachines* is published in the open access format. Research articles, reviews and other contents are released on the internet immediately after acceptance. The scientific community and the general public have unlimited free access to the content as soon as it is published. As an open access journal, *Micromachines* is supported by the authors or their institutes by payment of article processing charges (APC) for accepted papers. We are pleased to welcome you as our authors.

# **Author Benefits**

**Open Access:** free for readers, with article processing charges (APC) paid by authors or their institutions. **High Visibility:** indexed within Scopus, SCIE (Web of Science), PubMed, PMC, Ei Compendex, dblp, and other databases. **Journal Rank:** JCR - Q2 (*Chemistry, Analytical*) / CiteScore - Q2 (*Mechanical Engineering*)

# Contact Us

*Micromachines* Editorial Office MDPI, St. Alban-Anlage 66 4052 Basel, Switzerland Tel: +41 61 683 77 34 www.mdpi.com mdpi.com/journal/micromachines micromachines@mdpi.com X@micromach\_mdpi